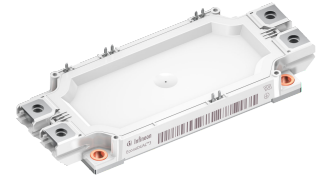


## Final datasheet

### EconoDUAL™3 module with Trench/Fieldstop IGBT4 and emitter controlled diode and NTC / pre-applied thermal interface material

#### Features

- Electrical features
  - $V_{CES} = 1700\text{ V}$
  - $I_{C\text{ nom}} = 600\text{ A} / I_{CRM} = 1200\text{ A}$
  - High current density
  - Low  $V_{CE,sat}$
  - $T_{vj,op} = 150^{\circ}\text{C}$
  - $V_{CE,sat}$  with positive temperature coefficient
- Mechanical features
  - High power density
  - Isolated base plate
  - Standard housing
  - Pre-applied thermal interface material



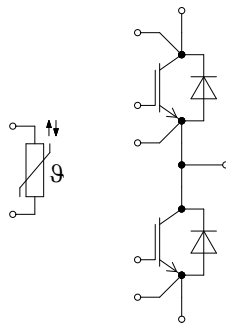
#### Potential applications

- High-power converters
- Wind turbines

#### Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

#### Description



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## 1 Package

**Table 1** Insulation coordination

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Isolation test voltage	$V_{ISOL}$	RMS, $f = 50$ Hz, $t = 1$ min	3.4			kV
Isolation test voltage NTC	$V_{ISOL(NTC)}$	RMS, $f = 50$ Hz, $t = 1$ min	3.4			kV
Material of module baseplate			Cu			
Internal isolation		basic insulation (class 1, IEC 61140)	$Al_2O_3$			
Creepage distance	$d_{Creep\ nom}$	terminal to baseplate, nom., (PD2, IEC 60664-1, Ed. 3.0)	> 15			mm
Creepage distance	$d_{Creep\ min}$	terminal to baseplate, min., (PD2, IEC 60664-1, Ed. 3.0)	14.7			mm
Creepage distance	$d_{Creep\ nom}$	terminal to terminal, nom., (PD2, IEC 60664-1, Ed. 3.0)	12.1			mm
Creepage distance	$d_{Creep\ min}$	terminal to terminal, min., (PD2, IEC 60664-1, Ed. 3.0)	11.5			mm
Clearance	$d_{Clear\ nom}$	terminal to baseplate, nom.	> 12.5			mm
Clearance	$d_{Clear\ min}$	terminal to baseplate, min.	12.5			mm
Clearance	$d_{Clear\ nom}$	terminal to terminal, nom.	10.0			mm
Clearance	$d_{Clear\ min}$	terminal to terminal, min.	9.6			mm
Comparative tracking index	$CTI$		> 200			
Relative thermal index (electrical)	$RTI$	housing	140			°C

**Table 2** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	$L_{sCE}$			20		nH
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_H = 25$ °C, per switch		1.1		mΩ
Storage temperature	$T_{stg}$		-40		125	°C
Maximum baseplate operation temperature	$T_{BPmax}$				125	°C
Mounting torque for module mounting	$M$	- Mounting according to valid application note	M5, Screw	3	6	Nm
Terminal connection torque	$M$	- Mounting according to valid application note	M6, Screw	3	6	Nm
Weight	$G$			345		g

**Note:** Storage and shipment of modules with TIM => see AN2012-07

## 2 IGBT, Inverter

**Table 3** Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Collector-emitter voltage	$V_{CES}$	$T_{vj} = 25\text{ °C}$	1700	V
Continuous DC collector current	$I_{CDC}$	$T_{vj\ max} = 175\text{ °C}$ $T_H = 50\text{ °C}$	600	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{vj\ op}$	1200	A
Gate-emitter peak voltage	$V_{GES}$		$\pm 20$	V

**Table 4** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 600\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$	1.95	2.30	V
			$T_{vj} = 125\text{ °C}$	2.35		
			$T_{vj} = 150\text{ °C}$	2.45		
Gate threshold voltage	$V_{GETh}$	$I_C = 24\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25\text{ °C}$	5.20	5.80	6.40	V
Gate charge	$Q_G$	$V_{GE} = \pm 15\text{ V}$		6.15		$\mu\text{C}$
Internal gate resistor	$R_{Gint}$	$T_{vj} = 25\text{ °C}$		1.2		$\Omega$
Input capacitance	$C_{ies}$	$f = 1000\text{ kHz}, T_{vj} = 25\text{ °C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		48		nF
Reverse transfer capacitance	$C_{res}$	$f = 1000\text{ kHz}, T_{vj} = 25\text{ °C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		1.55		nF
Collector-emitter cut-off current	$I_{CES}$	$V_{CE} = 1700\text{ V}, V_{GE} = 0\text{ V}$ $T_{vj} = 25\text{ °C}$			1	mA
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25\text{ °C}$			100	nA
Turn-on delay time (inductive load)	$t_{don}$	$I_C = 600\text{ A}, V_{CC} = 900\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Gon} = 1\ \Omega$	$T_{vj} = 25\text{ °C}$	0.200		$\mu\text{s}$
			$T_{vj} = 125\text{ °C}$	0.210		
			$T_{vj} = 150\text{ °C}$	0.240		
Rise time (inductive load)	$t_r$	$I_C = 600\text{ A}, V_{CC} = 900\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Gon} = 1\ \Omega$	$T_{vj} = 25\text{ °C}$	0.070		$\mu\text{s}$
			$T_{vj} = 125\text{ °C}$	0.080		
			$T_{vj} = 150\text{ °C}$	0.080		
Turn-off delay time (inductive load)	$t_{doff}$	$I_C = 600\text{ A}, V_{CC} = 900\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 1\ \Omega$	$T_{vj} = 25\text{ °C}$	0.620		$\mu\text{s}$
			$T_{vj} = 125\text{ °C}$	0.750		
			$T_{vj} = 150\text{ °C}$	0.800		

(table continues...)

**Table 4 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Fall time (inductive load)	$t_f$	$I_C = 600 \text{ A}, V_{CC} = 900 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{Goff} = 1 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$	0.110		$\mu\text{s}$
			$T_{vj} = 125 \text{ }^\circ\text{C}$	0.160		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	0.180		
Turn-on energy loss per pulse	$E_{on}$	$I_C = 600 \text{ A}, V_{CC} = 900 \text{ V}, L_\sigma = 80 \text{ nH}, V_{GE} = \pm 15 \text{ V}, R_{Gon} = 1 \Omega, di/dt = 6500 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$	140		mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$	210		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	225		
Turn-off energy loss per pulse	$E_{off}$	$I_C = 600 \text{ A}, V_{CC} = 900 \text{ V}, L_\sigma = 80 \text{ nH}, V_{GE} = \pm 15 \text{ V}, R_{Goff} = 1 \Omega, dv/dt = 3000 \text{ V}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$	115		mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$	180		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	205		
SC data	$I_{SC}$	$V_{GE} \leq 15 \text{ V}, V_{CC} = 1000 \text{ V}, V_{CEmax} = V_{CES} - L_{SCE} * di/dt$	$t_p \leq 10 \mu\text{s}, T_{vj} = 150 \text{ }^\circ\text{C}$	2300		A
Thermal resistance, junction to heat sink	$R_{thJH}$	per IGBT, Valid with IFX pre-applied Thermal Interface Material			0.0670	K/W
Temperature under switching conditions	$T_{vjop}$			-40	150	$^\circ\text{C}$

### 3 Diode, Inverter

**Table 5 Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj} = 25 \text{ }^\circ\text{C}$	1700	V	
Continuous DC forward current	$I_F$		600	A	
Repetitive peak forward current	$I_{FRM}$	$t_p = 1 \text{ ms}$	1200	A	
$I^2t$ - value	$I^2t$	$t_p = 10 \text{ ms}, V_R = 0 \text{ V}$	$T_{vj} = 125 \text{ }^\circ\text{C}$	32000	$\text{A}^2\text{s}$
			$T_{vj} = 150 \text{ }^\circ\text{C}$	30500	

**Table 6 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	$V_F$	$I_F = 600 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$	1.80	2.20	V
			$T_{vj} = 125 \text{ }^\circ\text{C}$	1.90		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	1.95		

(table continues...)

**Table 6 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Peak reverse recovery current	$I_{RM}$	$V_{CC} = 900\text{ V}, I_F = 600\text{ A}, V_{GE} = -15\text{ V}, -di_F/dt = 6500\text{ A}/\mu\text{s} (T_{vj} = 150\text{ }^\circ\text{C})$	$T_{vj} = 25\text{ }^\circ\text{C}$	580		A
			$T_{vj} = 125\text{ }^\circ\text{C}$	650		
			$T_{vj} = 150\text{ }^\circ\text{C}$	670		
Recovered charge	$Q_r$	$V_{CC} = 900\text{ V}, I_F = 600\text{ A}, V_{GE} = -15\text{ V}, -di_F/dt = 6500\text{ A}/\mu\text{s} (T_{vj} = 150\text{ }^\circ\text{C})$	$T_{vj} = 25\text{ }^\circ\text{C}$	150		$\mu\text{C}$
			$T_{vj} = 125\text{ }^\circ\text{C}$	250		
			$T_{vj} = 150\text{ }^\circ\text{C}$	285		
Reverse recovery energy	$E_{rec}$	$V_{CC} = 900\text{ V}, I_F = 600\text{ A}, V_{GE} = -15\text{ V}, -di_F/dt = 6500\text{ A}/\mu\text{s} (T_{vj} = 150\text{ }^\circ\text{C})$	$T_{vj} = 25\text{ }^\circ\text{C}$	75		mJ
			$T_{vj} = 125\text{ }^\circ\text{C}$	145		
			$T_{vj} = 150\text{ }^\circ\text{C}$	165		
Thermal resistance, junction to heat sink	$R_{thJH}$	per diode, Valid with IFX pre-applied Thermal Interface Material			0.107	K/W
Temperature under switching conditions	$T_{vj\text{op}}$		-40		150	$^\circ\text{C}$

## 4 NTC-Thermistor

**Table 7 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	$R_{25}$	$T_{NTC} = 25\text{ }^\circ\text{C}$		5		k $\Omega$
Deviation of $R_{100}$	$\Delta R/R$	$T_{NTC} = 100\text{ }^\circ\text{C}, R_{100} = 493\text{ }\Omega$	-5		5	%
Power dissipation	$P_{25}$	$T_{NTC} = 25\text{ }^\circ\text{C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$		3433		K

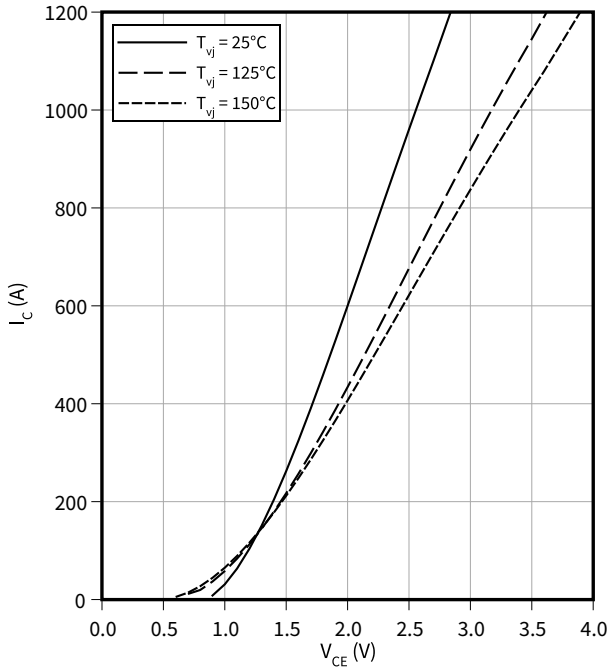
**Note:** For an analytical description of the NTC characteristics please refer to AN2009-10, chapter 4.

## 5 Characteristics diagrams

**Output characteristic (typical), IGBT, Inverter**

$$I_C = f(V_{CE})$$

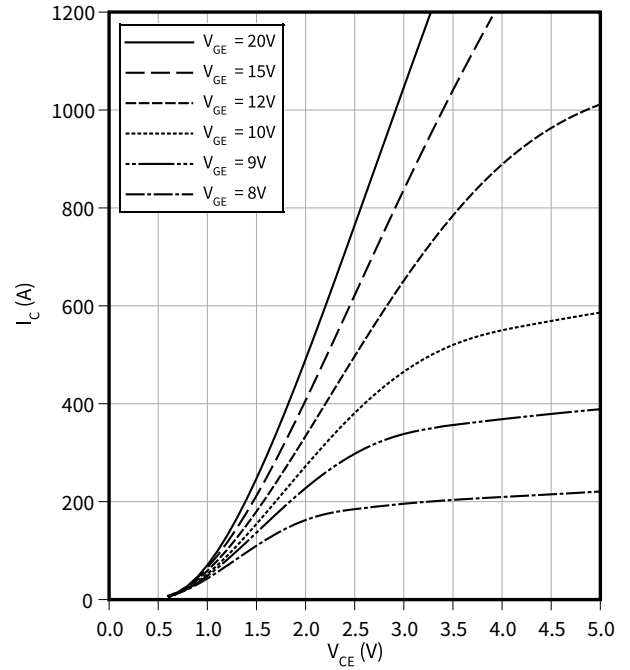
$$V_{GE} = 15 \text{ V}$$



**Output characteristic field (typical), IGBT, Inverter**

$$I_C = f(V_{CE})$$

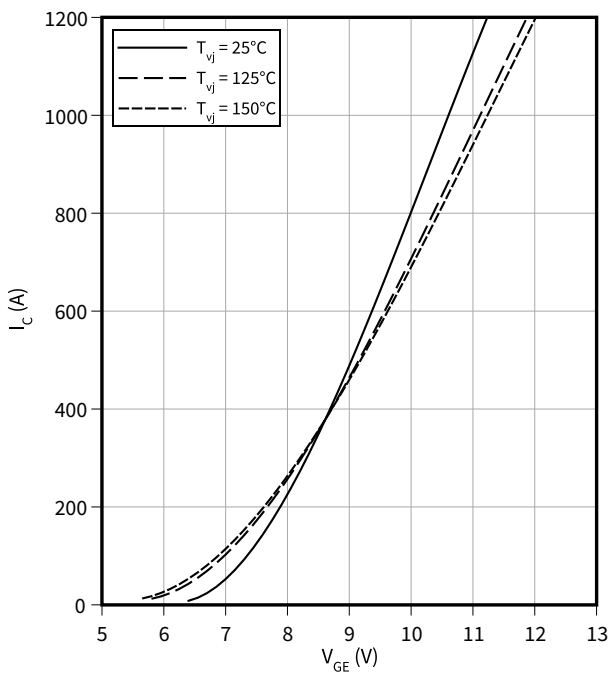
$$T_{vj} = 150 \text{ °C}$$



**Transfer characteristic (typical), IGBT, Inverter**

$$I_C = f(V_{GE})$$

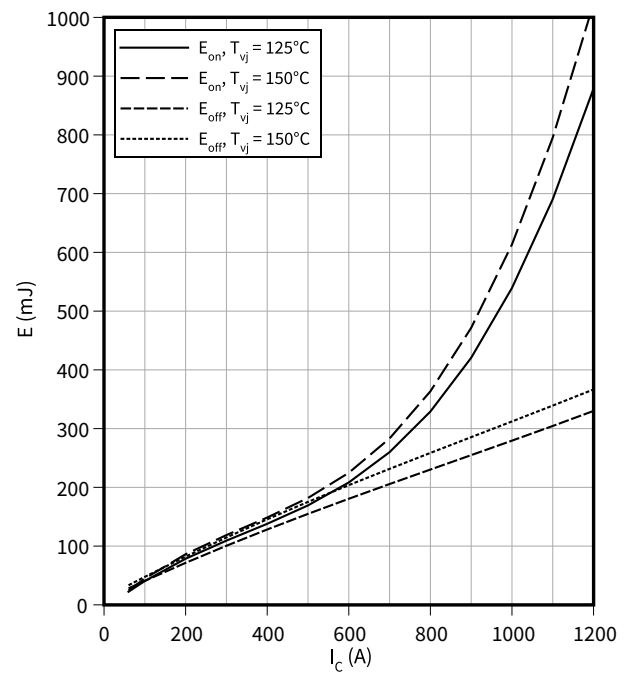
$$V_{CE} = 20 \text{ V}$$



**Switching losses (typical), IGBT, Inverter**

$$E = f(I_C)$$

$$R_{Goff} = 1 \text{ } \Omega, R_{Gon} = 1 \text{ } \Omega, V_{GE} = \pm 15 \text{ V}, V_{CC} = 900 \text{ V}$$

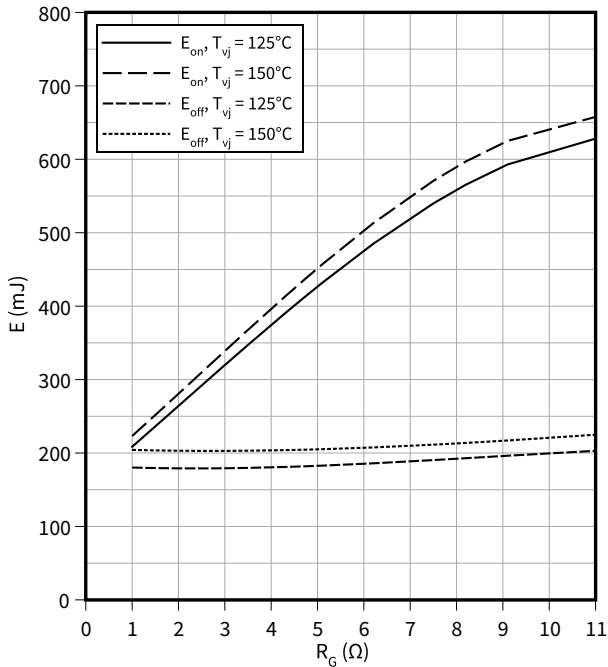


5 Characteristics diagrams

**Switching losses (typical), IGBT, Inverter**

$E = f(R_G)$

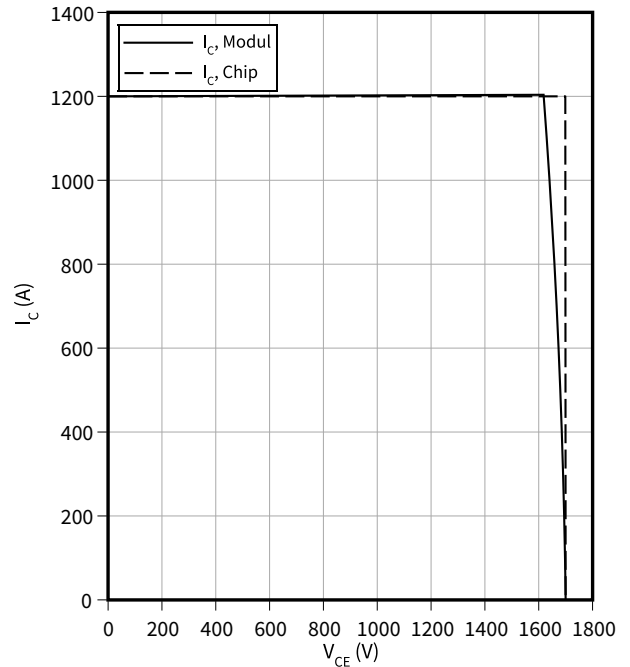
$V_{GE} = \pm 15 \text{ V}, I_C = 600 \text{ A}, V_{CC} = 900 \text{ V}$



**Reverse bias safe operating area (RBSOA), IGBT, Inverter**

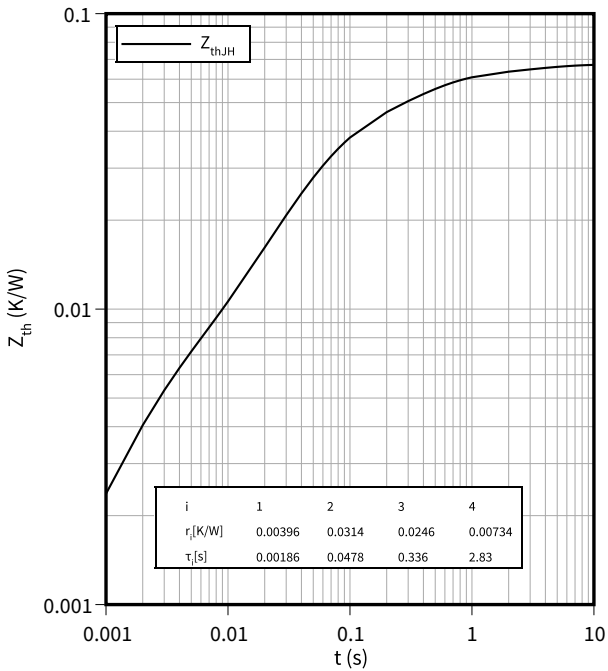
$I_C = f(V_{CE})$

$R_{Goff} = 1 \Omega, V_{GE} = \pm 15 \text{ V}, T_{vj} = 150 \text{ }^\circ\text{C}$



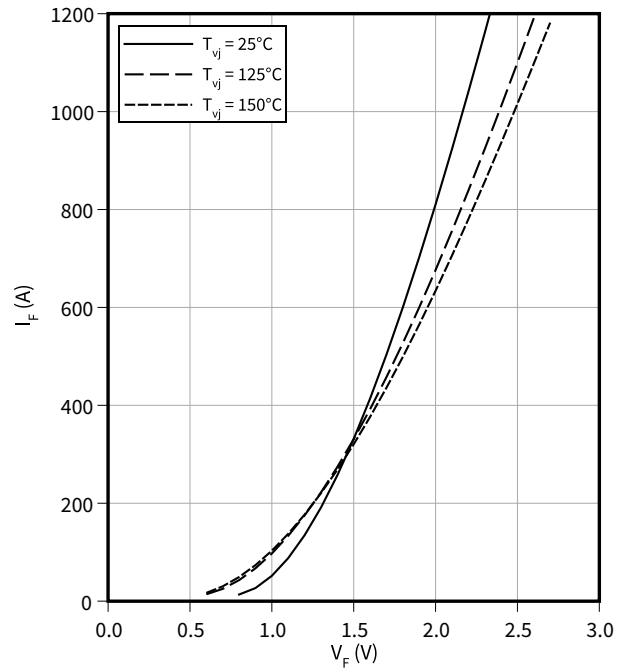
**Transient thermal impedance, IGBT, Inverter**

$Z_{th} = f(t)$



**Forward characteristic (typical), Diode, Inverter**

$I_F = f(V_F)$

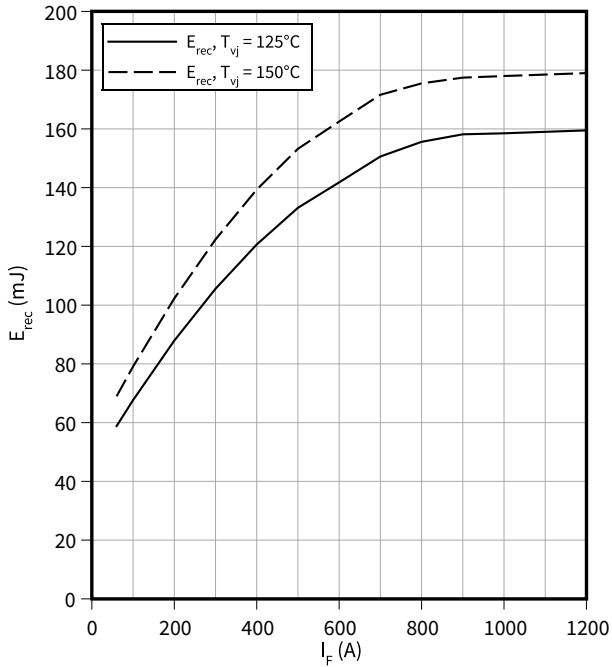


5 Characteristics diagrams

**Switching losses (typical), Diode, Inverter**

$E_{rec} = f(I_F)$

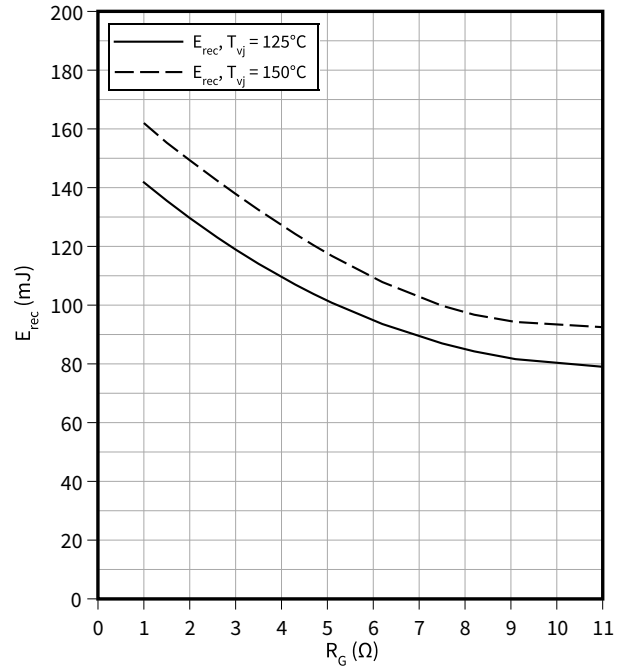
$R_{Gon} = 1 \Omega, V_{CC} = 900 V$



**Switching losses (typical), Diode, Inverter**

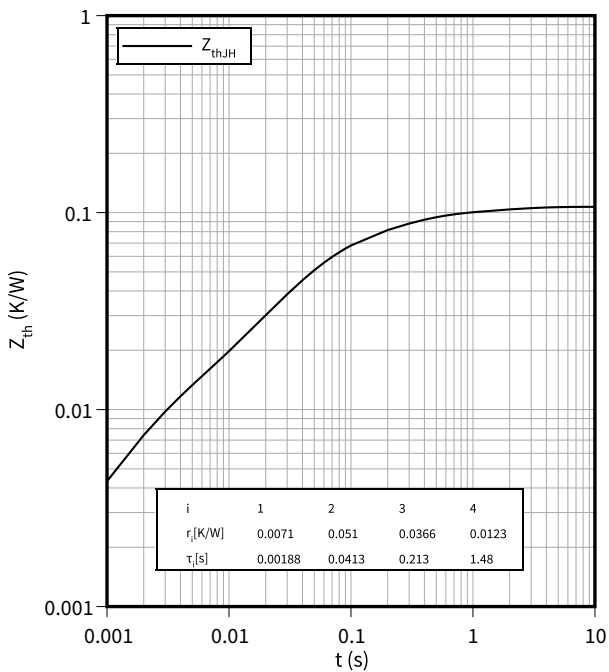
$E_{rec} = f(R_G)$

$I_F = 600 A, V_{CC} = 900 V$



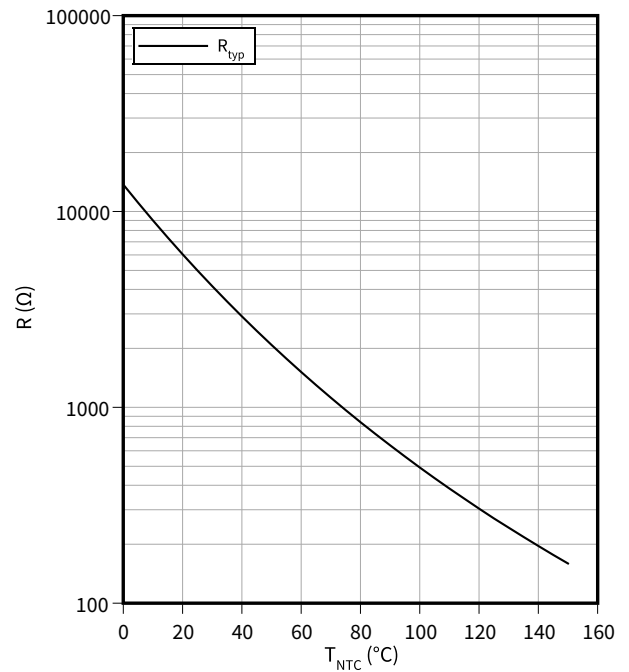
**Transient thermal impedance, Diode, Inverter**

$Z_{th} = f(t)$



**Temperature characteristic (typical), NTC-Thermistor**

$R = f(T_{NTC})$



## 6 Circuit diagram

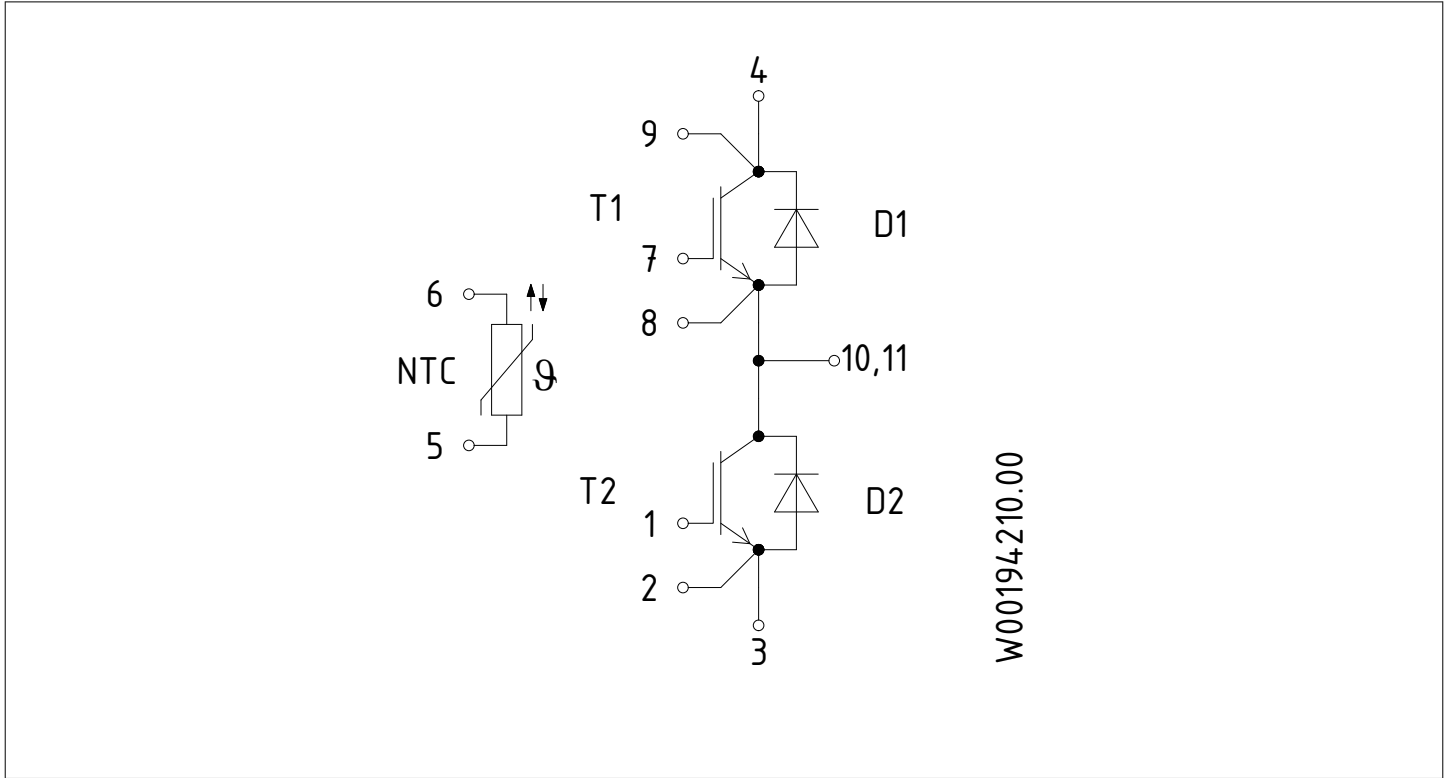


Figure 1

## 7 Package outlines

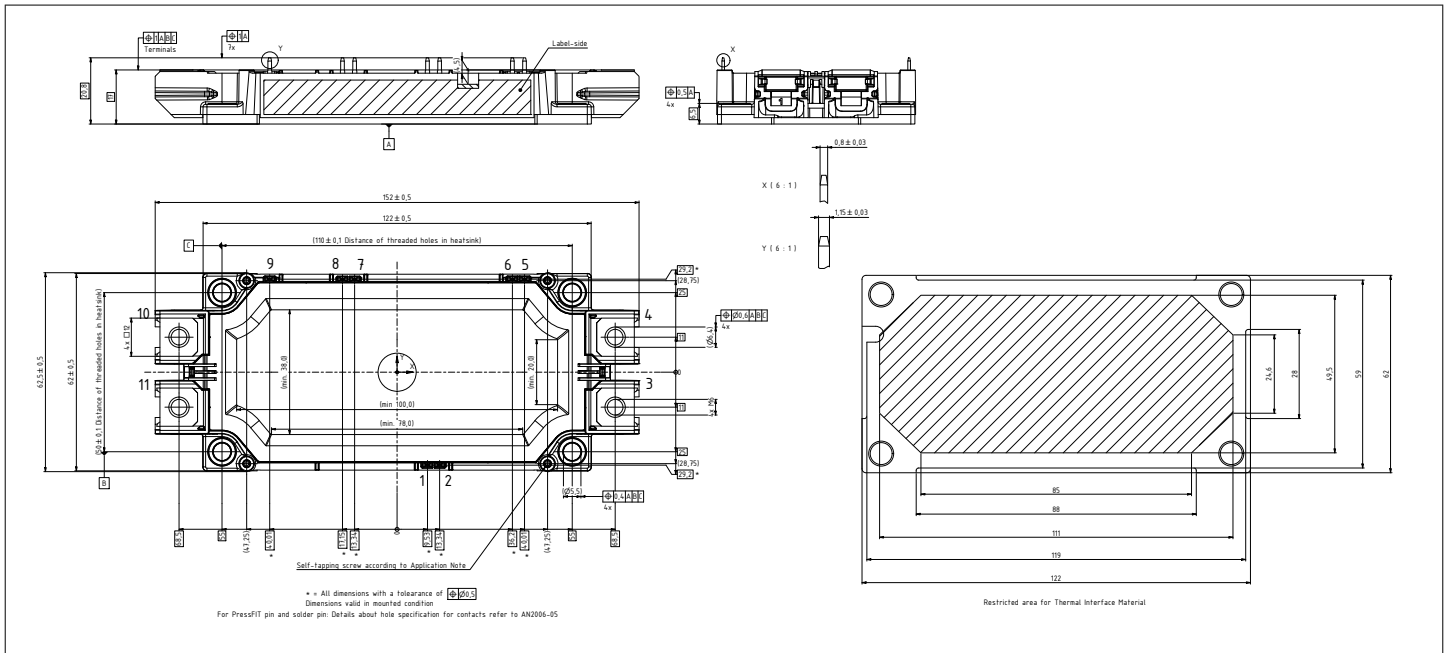

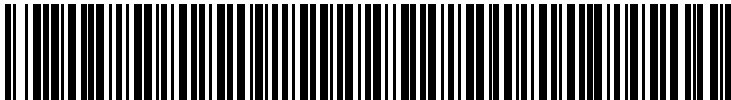


Figure 2

## 8 Module label code

Module label code			
Code format	Data Matrix	Barcode Code128	
Encoding	ASCII text	Code Set A	
Symbol size	16x16	23 digits	
Standard	IEC24720 and IEC16022	IEC8859-1	
Code content	Content	Digit	Example
	Module serial number	1 - 5	71549
	Module material number	6 - 11	142846
	Production order number	12 - 19	55054991
	Date code (production year)	20 - 21	15
	Date code (production week)	22 - 23	30
Example	 		
	71549142846550549911530		71549142846550549911530

**Figure 3**

## Revision history

Document revision	Date of release	Description of changes
V1.0	2012-08-21	Target datasheet
V3.0	2017-07-19	Final datasheet
n/a	2020-09-01	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
1.10	2024-03-18	Final datasheet

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**Document reference**

**IFX-AAX173-003**

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